



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	RDS(ON) Max	l _D Τ _C = +25°C
-40V	11mΩ @ V _{GS} = -10V	-35A
	15mΩ @ V _{GS} = -4.5V	-30A

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) test in production
- Low On-Resistance
- · Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 https://www.diodes.com/quality/product-definitions/
- An automotive-compliant part is available under separate

An automotive-compliant part is available under separate datasheet (<u>DMP4015SK3Q</u>)

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

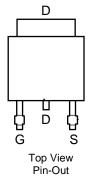
- DC-DC converters
- Power-management functions
- Backlighting

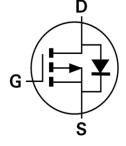
Mechanical Data

- Package: TO252
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208@3
- Weight: 0.33 grams (Approximate)



Top View





Equivalent Circuit

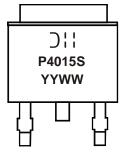
Ordering Information (Note 4)

Part Number	Dackers	Packing		
Part Number	Package	Qty.	Carrier	
DMP4015SK3-13	TO252 (DPAK)	2,500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Oll = Manufacturer's Marking
P4015S = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 23 = 2023)
WW = Week (01 to 53)



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	-40	V		
Gate-Source Voltage	Vgss	±25	V		
Continuous Drain Current (Note 5) V _{GS} = -10V	I _D	-35 -27	А		
Continuous Dunis Coursest (Note 5) Very 40V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	l _D	-14 -11	А
Continuous Drain Current (Note 5) Vgs = -10V	t < 10s	T _A = +25°C T _A = +70°C	l _D	-22 -18	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-100	Α		
Maximum Body Diode Forward Current (Note 5)	ls	-5.5	Α		
Avalanche Current L = 1mH	I _{AS}	-22	Α		
Avalanche Energy L = 1mH	Eas	242	mJ		

Thermal Characteristics (@ TA = +25°C, unless otherwise specified.)

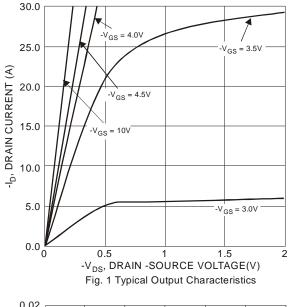
Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	D-	3.5	W
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	PD	2.2	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	36	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	Reja	15	
Thermal Resistance, Junction to Case (Note 5) Steady State		Rejc	4.5	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

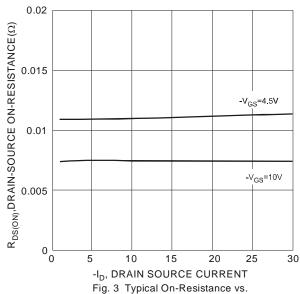
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

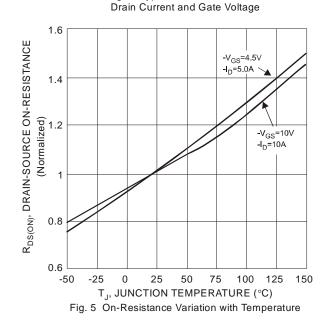
				•			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BVDSS	-40	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS		_	-1	μΑ	$V_{DS} = -40V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(TH)}	-1.5	-2	-2.5	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	Dagger		7	11	mΩ	$V_{GS} = -10V, I_{D} = -9.8A$	
Static Drain-Source On-Resistance	RDS(ON)		9	15	11177	$V_{GS} = -4.5V, I_{D} = -9.8A$	
Forward Transfer Admittance	Y _{fs}		26	_	S	$V_{DS} = -20V, I_{D} = -9.8A$	
Diode Forward Voltage	VsD	_	-0.7	-1	V	$V_{GS} = 0V$, $I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss		4,234	_		V _{DS} = -20V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss		1,036	_	pF		
Reverse Transfer Capacitance	Crss		526	_		1 = 11011 12	
Gate Resistance	Rg		7.77	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	47.5	_	1, 20, 1, 5,		
Gate-Source Charge	Qgs	_	14.2	_	nC	V _{DS} = -20V, V _{GS} = -5V I _D = -9.8A	
Gate-Drain Charge	Q_{gd}	_	13.5	_			
Turn-On Delay Time	td(ON)		13.2	_		V _G S = -10V, V _{DD} = -20V,	
Turn-On Rise Time	t _R		10	_	ns		
Turn-Off Delay Time	t _{D(OFF)}		302.7	_	115	$R_G = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	tF	_	137.9	_			

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to production testing. Notes:

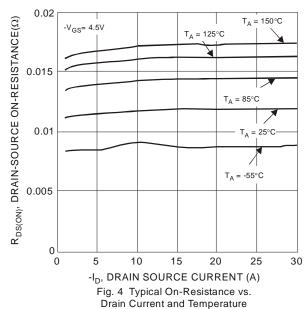








30 T_A = 150°C V_{DS}= -5.0∨ T_A = 25°C 25 T_A = 125°C -I_D, DRAIN CURRENT (A) 20 $T_A = -55^{\circ}C$ 15 T_A = 85°C 10 5 2 2.5 3 3.5 0 0.5 1 1.5 4 $-V_{\rm GS}$, GATE-SOURCE VOLTAGE (V) Fig. 2 Typical Transfer Characteristics



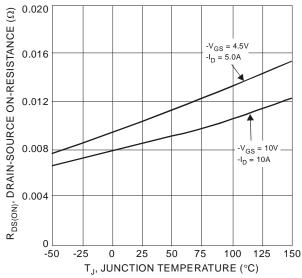


Fig. 6 On-Resistance Variation with Temperature



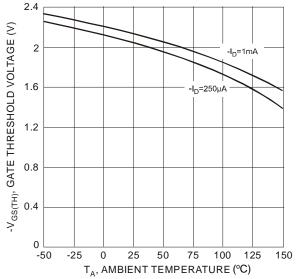
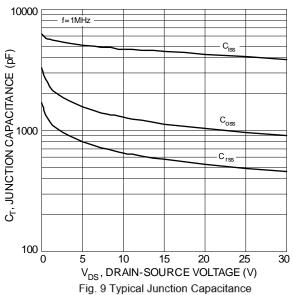
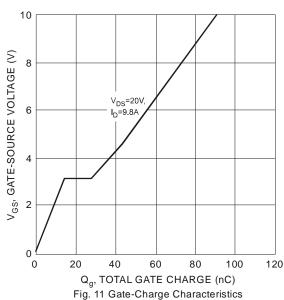


Fig. 7 Gate Threshold Variation vs. Ambient Temperature





30 25 T_A= 25°C -I_S, SOURCE CURRENT (A) 20 15 10 5 0 0 0.4 0.6 8.0 1.4 - V_{SD} , SOURCE-DRAIN VOLTAGE (V) Fig. 8 Diode Forward Voltage vs. Current

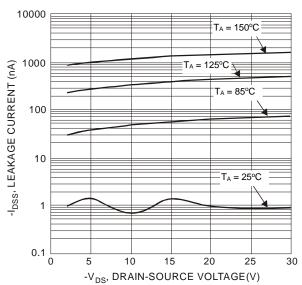


Fig. 10 Typical Drain-Source Leakage Current vs. Voltage

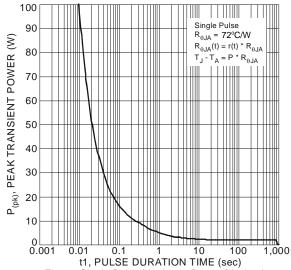
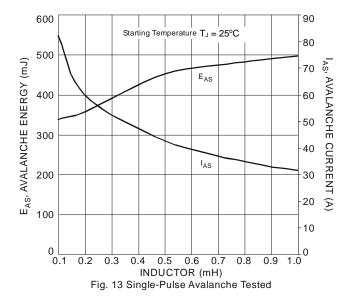
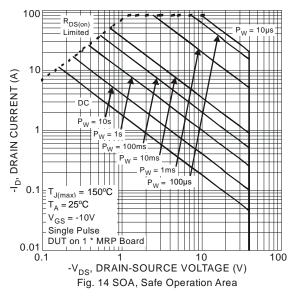


Fig. 12 Single Pulse Maximum Power Dissipation







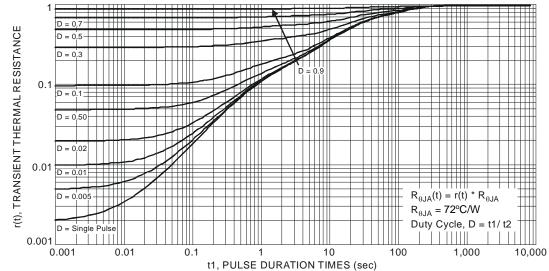


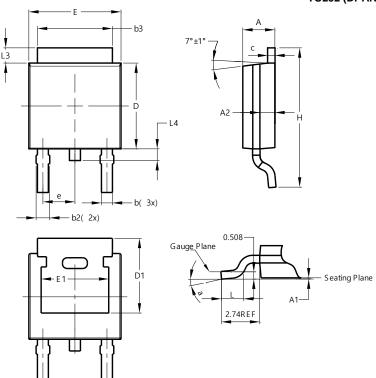
Fig. 15 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)

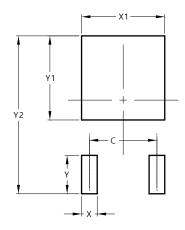


TO252 (DPAK)						
Dim	Min	Max	Тур			
Α	2.19	2.39	2.29			
A 1	0.00	0.13	0.08			
A2	0.97	1.17	1.07			
b	0.64	0.88	0.783			
b2	0.76	1.14	0.95			
b3	5.21	5.50	5.33			
С	0.45	0.58	0.531			
D	6.00	6.20	6.10			
D1	5.21					
е	2.	2.286 BSC				
Е	6.45	6.70	6.58			
E1	4.32					
Н	9.40	10.41	9.91			
L	1.40	1.78	1.59			
L3	0.88	1.27	1.08			
L4	0.64	1.02	0.83			
а	0°	10°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)			
С	4.572			
Х	1.060			
X1	5.632			
Υ	2.600			
Y1	5.700			
Y2	10.700			



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